

Approval Page - Do Not Distribute				
Title: EFM32HG Transition to Product Revision B				
Product Line: MCL	Js32-bit			
Product Family: Hap	py Gecko Enter additiona	l Product Families here.		
		estricted (List end customer/s):		
(All	Customers)			
Affected Depts:				
Design Engineering	🗌 Mfg. Tech	🛛 Quality & Reliability		
⊠ Logistics	🛛 Marketing	🖂 Sales		
🛛 Mfg. Engineering	Purchasing	☑ Test/Product Engr		
🛛 Mfg. Planning	🗌 Other (list l	pelow) 🛛 Other (list below)		
		Applications Engineering		
CR151028-693CAB # (So and Customer Notification		Engineering. Verify status is at "Change Approved		
Originator: Alf Petter A	Mossevig			
· · · ·	by name, from each affected o vers must approve the PCN for every PCN	ept checked above		
	Disc	ipline		
Design: Click here to er	nter text.	♦Mktg: Alf Petter Mossevig		
Logistics: Click here to	enter text.	Mktg Director: Tom Pannell		
Mfg Eng: Fong Yee Lai		Purch: Click here to enter text.		
Mfg Planning: Duc Tran		<b>♦Q&amp;R: Kathy Torres</b>		
Mfg Tech: Click here to enter text.		♦Sales: Kathy Haggar		
Test/Prod Eng: Vu Do				

Revision Control Instructions: Post Hardcopy Revisions: Yes Items for Hardcopy Release: All pages except Rev History Location: Silicon Labs Internal Web Quality PCN page-PCN Create/Approval Library(1)



text.

#### **Checklist - Do Not Distribute** Title: EFM32HG Transition to Product Revision B Automotive PCN: No 🛛 Yes, PPAP# Requirements Target Date Assigned To: **Completion Status** Qualification 11/30/2015 Tingting Tang No 🗆 N/A 🗆 Yes 🖂 Completion Jedec Timing (i.e. 90 Click here to enter a Click here to enter Yes 🖂 No 🗆 N/A 🗆 days) date. text. Master Data Click here to enter a Click here to enter No 🗆 N/A 🗆 Yes 🗆 Requirements date. text. Click here to enter a AOS Click here to enter Yes 🖂 No 🗌 N/A 🗆 date. text. Datasheet 12/4/2015 Tabitha Parker Yes 🖂 No 🗆 N/A 🗆 Recipes Click here to enter a Click here to enter Yes 🖂 No D N/A D date. text. PPAP Click here to enter a Click here to enter Yes $\Box$ No $\Box$ N/A $\Box$ date. text. Click here to enter Other Click here to Click here to enter a Yes 🗆 No 🗆 N/A 🗆 date. enter text. text. Samples Click here to enter a Click here to enter

date.

Part Number	QTY	CFG #	Available Y/N	BE Lot #	F/G Available	Cust Restriction in Place Y/N
EFM32HG108F64G-B- QFN24	200		Y			
EFM32HG110F64G-B- QFN24	200		Y			
EFM32HG210F64G-B- QFN32	200		Y			
EFM32HG222F64G-B- QFP48	200		Y			
EFM32HG308F64G-B- QFN24	200		Y			
EFM32HG309F64G-B- QFN24	200		Y			
EFM32HG310F64G-B- QFN32	200		Y			
EFM32HG321F64G-B- QFP48	200		Y			
EFM32HG322F64G-B- QFP48	200		Y			
EFM32HG350F64G-B- CSP36	200		Y			

[+ To add row(s), Tab out of last cell on right]

Please complete below blue sections for deviations to above Requirements :

Yes 🖂

No 🗆 N/A 🗆

⊠ N/A

**Deviation Request (Be Specific):** 

Click here to enter text.

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possible risk would be delay of provided, then a possible risk	ciated with this deviation of qualification completion due would be insufficient time allo	to qualification failures. 2. If	90 day's approval is not			
Click here to enter text. Business Case (Why should this deviation be considered by Silicon Labs?)						
Click here to enter text		Sidered by Silicon Labs:				
Customer Special PCN R	Requirements: Check CSR required with a cross reference					
□ Alcatel-Lucent	□ FoxConn Technology Co	□ IBM	🗆 Sumitomo			
🗆 Canon	🗆 Fujitsu	🗆 LGE	🗆 Varian			
	🗆 Honeywell	🗆 Nokia	Zhen Ding Technology			
🗆 Delphi	□ Hon Hai Precision	🗆 Panasonic				
	HongFu Jin Pirelli Precision Industry					
Epson	□ HongFuTai Precision □ Porter Electrons (Yantal)					
Foxconn International Holdings						
	Check CSR POS Report. with a cross reference to the					
□ Alcatel-Lucent	□ Foxconn International Holdings □ HongFu Jin Precision Industry □ Panasonic					
Canon	FoxConn Technology Co	□ HongFuTai Precision Electronics (Yantai)	Porter			
	🗆 Fujitsu	🗆 Huawei	🗵 Samsung			
🗆 Delphi	Honeywell	🗆 IBM	🗆 Sumitomo			
Epson	□ I GE □ 7hen Ding					
□ POS Checked-none shipped to CSR Customer. <b>Note</b> : See Inside Sales for ship history of products acquired through acquisition where ship history from Silicon Labs is less than two years.						
Customer List (if applicable): (embed a file of all customers who were shipped parts at end of form)						
WIP Dispostion:						
• Distributor Inventory: 🛛 Use 🗆 Re-Process 🗆 Scrap 🗆 None 🔅 🗆 Other 🗆 N/A						
Comments: Click here to enter text.						
• RMA Material: ⊠ Use □ Re-Process □ Scrap □ None □ Other □ N/A						
Comments: Click here to enter text.						



• EVAL/Dev Kits: 🛛 Use 🗆 Re-Process 🗆 Scrap 🗆 None 🗆 Other 🗆 N/A

Comments: Click here to enter text.

**3**<sup>rd</sup> **Party Certifications:**  $\Box$  Released  $\Box$  In Process  $\Box$  Not Required  $\boxtimes$  N/A

Assigned To: Click here to enter text. Target Completion date: Click here to enter text.

**Cancellation:**  $\boxtimes$  N/A  $\square$  Cancelled (Add "Cancelled" watermark to the form before submit) Comments: Click here to enter text.



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PCN Date: 1/20/2016		Effective Date: 4/26/2016			
Title: EFM32HG Transition to Product Revision B					
Originator: Alf Petter Mossevig	ginator: Alf Petter Mossevig Phon		Dept: Marketing		
Customer Contact: Kathy Haggar	Phon	e: 512-532-5261	Dept: Sales		
РСМ Туре:					
⊠ Datasheet					
Product Revision					
PCN Details					



### Description of Change:

Silicon Labs is pleased to announce revision B of the EFM32HG (Happy Gecko) devices and revision 1.00 of the corresponding datasheet for these products.

The following datasheets are updated to version 1.00: EFM32HG108 EFM32HG110 EFM32HG210 EFM32HG222 EFM32HG308 EFM32HG309 EFM32HG310 EFM32HG321 EFM32HG322 EFM32HG350 Rev B Errata documents and updated Errata History documents are available for: EFM32HG108 EFM32HG110 EFM32HG210 EFM32HG222 EFM32HG308 EFM32HG309 EFM32HG310 EFM32HG321 EFM32HG322 EFM32HG350 Revision B eliminates the following errata in product revision A: **EMU E108** GPIO E102 PKG\_E101 RMU\_E101 After the effective date of this PCN, Silicon Labs reserves the right to deliver revision B for customers ordering revision A.

#### Reason for Change:

Die revision to correct errata. Also updated specifications based on the results of additional silicon characterization.



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### Impact on Form, Fit, Function, Quality, Reliability:

There is no impact to form, fit, quality, or reliability.

The following functions are impacted:

- Updated device revision information in ROM Table (PID0 PID3 registers):
  - Minor Revision will now read 0x01 (Rev B) instead of 0x00 (Rev A).
- Eliminated errata:
  - EMU\_E108
  - o GPIO\_E102
  - PKG\_E101
  - o RMU\_E101



isting Part Number	Replacement Part Number	Drop In Compatible?
M32HG108F32G-A-QFN24	EFM32HG108F32G-B-QFN24	Yes
M32HG108F64G-A-QFN24	EFM32HG108F64G-B-QFN24	Yes
M32HG110F32G-A-QFN24	EFM32HG110F32G-B-QFN24	Yes
M32HG110F64G-A-QFN24	EFM32HG110F64G-B-QFN24	Yes
M32HG210F32G-A-QFN32	EFM32HG210F32G-B-QFN32	Yes
M32HG210F64G-A-QFN32	EFM32HG210F64G-B-QFN32	Yes
M32HG222F32G-A-QFP48	EFM32HG222F32G-B-QFP48	Yes
M32HG222F64G-A-QFP48	EFM32HG222F64G-B-QFP48	Yes
M32HG308F32G-A-QFN24	EFM32HG308F32G-B-QFN24	Yes
M32HG308F64G-A-QFN24	EFM32HG308F64G-B-QFN24	Yes
M32HG309F32G-A-QFN24	EFM32HG309F32G-B-QFN24	Yes
M32HG309F64G-A-QFN24	EFM32HG309F64G-B-QFN24	Yes
M32HG310F32G-A-QFN32	EFM32HG310F32G-B-QFN32	Yes
M32HG310F64G-A-QFN32	EFM32HG310F64G-B-QFN32	Yes
M32HG321F32G-A-QFP48	EFM32HG321F32G-B-QFP48	Yes
M32HG321F64G-A-QFP48	EFM32HG321F64G-B-QFP48	Yes
M32HG322F32G-A-QFP48	EFM32HG322F32G-B-QFP48	Yes
M32HG322F64G-A-QFP48	EFM32HG322F64G-B-QFP48	Yes
M32HG350F32G-A-QFP48	EFM32HG350F32G-B-QFP48	Yes
M32HG350F64G-A-QFP48	EFM32HG350F64G-B-QFP48	Yes
M32HG108F32G-A-QFN24R	EFM32HG108F32G-B-QFN24R	Yes
M32HG108F64G-A-QFN24R	EFM32HG108F64G-B-QFN24R	Yes
M32HG110F32G-A-QFN24R	EFM32HG110F32G-B-QFN24R	Yes
M32HG110F64G-A-QFN24R	EFM32HG110F64G-B-QFN24R	Yes
M32HG210F32G-A-QFN32R	EFM32HG210F32G-B-QFN32R	Yes
M32HG210F64G-A-QFN32R	EFM32HG210F64G-B-QFN32R	Yes
M32HG222F32G-A-QFP48R	EFM32HG222F32G-B-QFP48R	Yes
M32HG222F64G-A-QFP48R	EFM32HG222F64G-B-QFP48R	Yes
M32HG308F32G-A-QFN24R	EFM32HG308F32G-B-QFN24R	Yes
M32HG308F64G-A-QFN24R	EFM32HG308F64G-B-QFN24R	Yes
M32HG309F32G-A-QFN24R	EFM32HG309F32G-B-QFN24R	Yes
M32HG309F64G-A-QFN24R	EFM32HG309F64G-B-QFN24R	Yes
M32HG310F32G-A-QFN32R	EFM32HG310F32G-B-QFN32R	Yes
M32HG310F64G-A-QFN32R	EFM32HG310F64G-B-QFN32R	Yes
M32HG321F32G-A-QFP48R	EFM32HG321F32G-B-QFP48R	Yes
M32HG321F64G-A-QFP48R	EFM32HG321F64G-B-QFP48R	Yes
M32HG322F32G-A-QFP48R	EFM32HG322F32G-B-QFP48R	Yes
M32HG322F64G-A-QFP48R	EFM32HG322F64G-B-QFP48R	Yes

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EFM32HG350F32G-A-	QFP48R	EFM32HG350F32G-B-QFP4	18R Yes
EFM32HG350F64G-A-	QFP48R	EFM32HG350F64G-B-QFP4	18R Yes
Last Date of Unchange	ed Product	:: 4/26/2016	
Qualification Samples	:		
		se contact your Silicon Labs s entatives is available at <u>www</u>	sales representative to order samples. <u>v.silabs.com</u> .
written notice is subn about this notificatior	nitted with n, please c	nin 30 days of this notice. T	nsidered on a case by case basis if To request further data or inquire lbs sales representative. A list of <u>ps.com</u> .
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Customers may appro	ve early P	CN acceptance by completin	ng the information below:
Early Acceptance:	Date:		
	Name: _		
	Company	/:	
Email your early Acce	ptance ap	proval to: <u>katherine.haggar</u>	r@silabs.com
Qualification Data:			
Please see below.			



### EFM32HG\* Qualification Report



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Part Re∨A1,	art Rev A1, TSMC Fabrication, ASEKR Assembly except as noted						
Fest Name	Test Condition	Qualification	Lot ID or	Fail/Pass or	Notes	Summary	Status
			Start	End			
	ccelerated Environment Stress	: Tests - USP - AS		0.005			
HAST			Q37113	0/25	1		
	JA110		Q37378	0/26	1		_
	130°C, 85%RH	3 lots, N=>25	Q37419	1/26	1	4 lots	Pass
	Vcc=3.8V, 96 hours		Q37744	0/20	1	1/97	
Tem p Cycle	JA104		Q37114	0/27	1		_
	Cond C: -65°C to 150°C	3 lots, N=>25	Q37377	0/26	1	3 lots	Pass
	500 cycles		Q37418	0/27	1	0/80	
HTSL	JA103		Q37111	0/27			
	150°C, 1000hr	3 lots, N=>25	Q37374	0/25		3 lots	Pass
			Q37415	0/27		0/79	
	ccelerated Environment Stress	Tests - QFP	-				
HAST	JA110		Q37011	0/30	2		
	130°C, 85%RH	3 lots, N=>25	Q37006	0/30	2	3 lots	Pass
	Vcc=3.8V, 96 hours		Q36990	0/30	2	0/90	
uHA ST	JA118		Q37014	0/30	2		
	130°C, 85%RH	3 lots, N=>25	Q37009	0/30	2	3 lots	Pass
	96 hours		Q37005	0/30	2	0/90	
Tem p Cycle	JA104		Q37013	0/30	2		
	Cond C: -65°C to 150°C	3 lots, N=>25	Q37008	0/30	2	3 lots	Pass
	500 cycles		Q37000	0/30	2	0/90	
HTSL	JA103		Q37012	0/30	2		
	150°C, 1000hr	3 lots, N=>25	Q37007	0/30	2	3 lots	Pass
			Q36999	0/30	2	0/90	
Fest Group A - A	ccelerated Environment Stress	Tests - QFN					
HAST	JA110		Q37246	0/30	2		
	130°C, 85%RH	3 lots, N=>25	Q37242	0/30	2	3 lots	Pass
	Vcc=3.8V, 96 hours		Q36986	0/30	2	0/90	
JHAST	JA118		Q37247	0/30	2		
	130°C, 85%RH	3 lots, N=>25	Q37243	0/30	2	3 lots	Pass
	96 hours		Q36987	0/30	2	0/90	
Fem p Cycle	JA104		Q372.48	0/30	2		
	Cond C: -65°C to 150°C	3 lots, N=>25	Q372.44	0/30	2	3 lots	Pass
	500 cycles		Q36988	0/30	2	0/90	
HTSL	JA103		Q36989	0/30	2		
	150°C, 1000hr	3 lots, N=>25	Q37245	0/30	2	3 lots	Pass
			Q37249	0/30	2	0/90	

Approved by: Kathy Torres



### EFM32HG\* Qualification Report

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Part Rev A1,	TSMC Fabrication, ASE	(R Assembly ex	cept as n	ioted			
Test Group B - A	ccelerated Lifetime Simulation	on Tests					
HTOL	JA108		Q36985	0/80			
	125°C, Dynamic	3 lots, N=>77	Q34509	0/80		3 lots	Pass
	Vcc=3.8V, 1000 hours		Q35572	0/80		0/240	
LTOL	JA108						
	-10°C, Dynamic	1 lot, N=>32	Q34510	0/40		1 lots	Pass
	Vcc=3.8V, 1000 hours					0/40	
ELFR	JA108		Q36939	0/508			
	125°C, Dynamic	3 lots, N=>500	Q34886	0/520		3 lots	Pass
	Vcc=3.8V, 48 hours		Q34894	0/503		0/1531	
NVM HTDR	JESD22- A117		Q34896	0/39			
	150°C, 1000 hours	3 lots, N=>39	Q34888	0/40		3 lots	Pass
			Q34513	0/39		0/118	
NVM LTDR	JESD22-A117		Q34895	0/40			
	25°C, 500 hours	3 lots, N=>38	Q34887	0/40		3 lots	Pass
			Q34514	0/39		0/119	
Test Group E - E	lectrical Verification						
ESD-HBM	JA114						
		1 lot, N=>3	Q37025				±2500 V
ESD-CDM	JC101		Q37115		3		±500 V
		1 lot, N=>3	Q36943		4		±1500 V
			Q36934		5		±1500 V
			Q37105		6		±1500 V
Latch Up	JESD78						150
		1 lot, N=>3	Q37022 Q37020	85 °C			±150mA ±200mA
	Overvoltage = 3.8V		1 201020	25 °C			7200 mA

Notes:

1. Parts are Pre-conditioned at MSL1/260 °C

2. Parts are Pre-conditioned at MSL3/260 °C

WLC SP Package

4. 7×7 48 QFN

5. 6x6 32 QFN

6. 5×5 24 QFN

This report applies to the following part numbers:						
EFM32HG108F32G-B-QFN24	E FM32HG222F64G-B-QFP48	EFM32HG321F32G-B-QFP48				
EFM32HG108F64G-B-QFN24	EFM32HG308F32G-B-QFN24	EFM32HG321F64G-B-QFP48				
EFM32HG110F32G-B-QFN24	EFM32HG308F64G-B-QFN24	EFM32 HG322 F32 G-B- QFP48				
EFM32HG110F64G-B-QFN24	EFM32HG309F32G-B-QFN24	EFM32HG322F64G-B-QFP48				
EFM32HG210F32G-B-QFN32	EFM32HG309F64G-B-QFN24	EFM32 HG350 F32 G-B-C5P36				
EFM32HG210F64G-B-QFN32	EFM32HG310F32G-B-QFN32	EFM32HG350F64G-B-CSP36				
EFM32HG222F32G-B-QFP48	EFM32HG310F64G-B-QFN32					

Approved by: Kathy Torres

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Prepared on: 27-Oct-2015

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